

# MC74HC4851A, MC74HC4852A

## Analog Multiplexers/ Demultiplexers with Injection Current Effect Control

### Automotive Customized

These devices are pin compatible to standard HC405x and MC1405xB analog mux/demux devices, but feature injection current effect control. This makes them especially suited for usage in automotive applications where voltages in excess of normal logic voltage are common.

The injection current effect control allows signals at disabled analog input channels to exceed the supply voltage range without affecting the signal of the enabled analog channel. This eliminates the need for external diode/ resistor networks typically used to keep the analog channel signals within the supply voltage range.

The devices utilize low power silicon gate CMOS technology. The Channel Select and Enable inputs are compatible with standard CMOS outputs.

#### Features

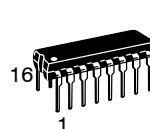
- Injection Current Cross-Coupling Less than 1mV/mA (See Figure 9)
- Pin Compatible to HC405X and MC1405XB Devices
- Power Supply Range ( $V_{CC} - GND$ ) = 2.0 to 6.0 V
- In Compliance With the Requirements of JEDEC Standard No. 7A
- Chip Complexity: 154 FETs or 36 Equivalent Gates
- NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free and are RoHS Compliant



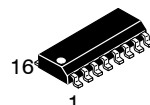
ON Semiconductor®

<http://onsemi.com>

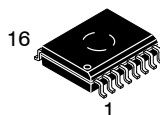
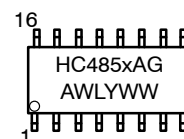
#### MARKING DIAGRAMS



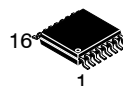
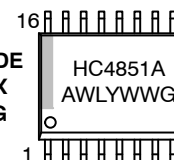
PDIP-16  
N SUFFIX  
CASE 648



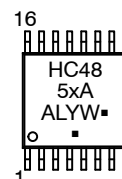
SOIC-16  
D SUFFIX  
CASE 751B



SOIC-16 WIDE  
DW SUFFIX  
CASE 751G



TSSOP-16  
DT SUFFIX  
CASE 948F

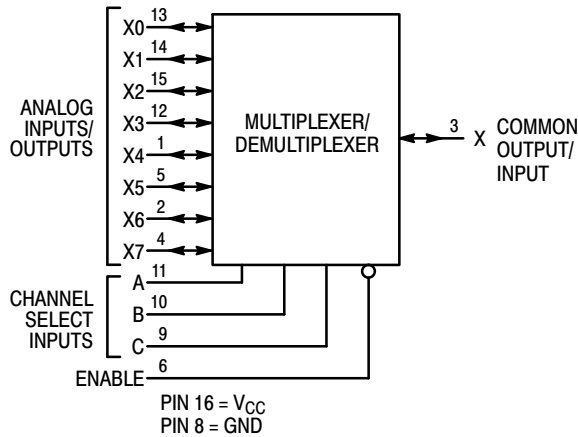


x = 1 or 2  
A = Assembly Location  
WL, L = Wafer Lot  
YY, Y = Year  
WW, W = Work Week  
G or ■ = Pb-Free Package  
(Note: Microdot may be in either location)

#### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 12 of this data sheet.

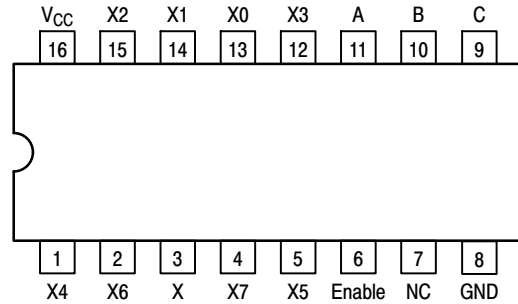
# MC74HC4851A, MC74HC4852A



**Figure 1. MC74HC4851A Logic Diagram**  
**Single-Pole, 8-Position Plus Common Off**

**FUNCTION TABLE – MC74HC4851A**

Control Inputs				ON Channels
Enable	Select			
	C	B	A	
L	L	L	L	X0
L	L	L	H	X1
L	L	H	L	X2
L	L	H	H	X3
L	H	L	L	X4
L	H	L	H	X5
L	H	H	L	X6
L	H	H	H	X7
H	X	X	X	NONE

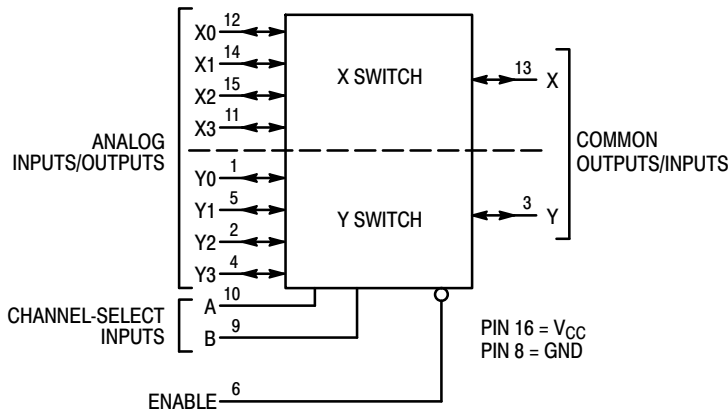


**Figure 2. MC74HC4851A 16-Lead Pinout (Top View)**

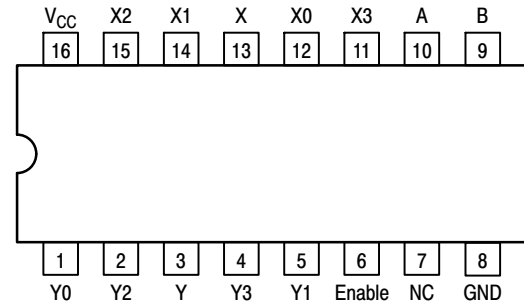
**FUNCTION TABLE – MC74HC4852A**

Control Inputs				
Enable	Select			
	B	A	ON Channels	
L	L	L	Y0	X0
L	L	H	Y1	X1
L	H	L	Y2	X2
L	H	H	Y3	X3
H	X	X	NONE	

X = Don't Care



**Figure 3. MC74HC4852A Logic Diagram**  
**Double-Pole, 4-Position Plus Common Off**



**Figure 4. MC74HC4852A 16-Lead Pinout (Top View)**

# MC74HC4851A, MC74HC4852A

## MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
$V_{CC}$	Positive DC Supply Voltage (Referenced to GND)	-0.5 to + 7.0	V
$V_{in}$	DC Input Voltage (Any Pin) (Referenced to GND)	-0.5 to $V_{CC} + 0.5$	V
I	DC Current, Into or Out of Any Pin	$\pm 25$	mA
$P_D$	Power Dissipation in Still Air, Plastic DIP† SOIC Package† TSSOP Package†	750 500 450	mW
$T_{stg}$	Storage Temperature Range	-65 to + 150	°C
$T_L$	Lead Temperature, 1 mm from Case for 10 Seconds Plastic DIP, SOIC or TSSOP Package	260	°C

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation,  $V_{in}$  and  $V_{out}$  should be constrained to the range  $GND \leq (V_{in} \text{ or } V_{out}) \leq V_{CC}$ . Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or  $V_{CC}$ ). Unused outputs must be left open.

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

†Derating – Plastic DIP: - 10 mW/°C from 65° to 125°C  
SOIC Package: - 7 mW/°C from 65° to 125°C  
TSSOP Package: - 6.1 mW/°C from 65° to 125°C

## RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit
$V_{CC}$	Positive DC Supply Voltage (Referenced to GND)	2.0	6.0	V
$V_{in}$	DC Input Voltage (Any Pin) (Referenced to GND)	GND	$V_{CC}$	V
$V_{IO}^*$	Static or Dynamic Voltage Across Switch	0.0	1.2	V
$T_A$	Operating Temperature Range, All Package Types	- 55	+ 125	°C
$t_r, t_f$	Input Rise/Fall Time (Channel Select or Enable Inputs) $V_{CC} = 2.0 \text{ V}$ $V_{CC} = 4.5 \text{ V}$ $V_{CC} = 6.0 \text{ V}$	0 0 0	1000 500 400	ns

\*For voltage drops across switch greater than 1.2 V (switch on), excessive  $V_{CC}$  current may be drawn; i.e., the current out of the switch may contain both  $V_{CC}$  and switch input components. The reliability of the device will be unaffected unless the Maximum Ratings are exceeded.

## DC CHARACTERISTICS — Digital Section (Voltages Referenced to GND) $V_{EE} = GND$ , Except Where Noted

Symbol	Parameter	Condition	$V_{CC}$ V	Guaranteed Limit			Unit
				-55 to 25°C	≤85°C	≤125°C	
$V_{IH}$	Minimum High-Level Input Voltage, Channel-Select or Enable Inputs	$R_{on} = \text{Per Spec}$	2.0	1.50	1.50	1.50	V
			3.0	2.10	2.10	2.10	
			4.5	3.15	3.15	3.15	
			6.0	4.20	4.20	4.20	
$V_{IL}$	Maximum Low-Level Input Voltage, Channel-Select or Enable Inputs	$R_{on} = \text{Per Spec}$	2.0	0.50	0.50	0.50	V
			3.0	0.90	0.90	0.90	
			4.5	1.35	1.35	1.35	
			6.0	1.80	1.80	1.80	
$I_{in}$	Maximum Input Leakage Current on Digital Pins (Enable/A/B/C)	$V_{in} = V_{CC} \text{ or } GND$	6.0	$\pm 0.1$	$\pm 1.0$	$\pm 1.0$	μA
$I_{CC}$	Maximum Quiescent Supply Current (per Package)	$V_{in(digital)} = V_{CC} \text{ or } GND$ $V_{in(analog)} = GND$	6.0	2	20	40	μA

# MC74HC4851A, MC74HC4852A

## DC CHARACTERISTICS — Analog Section

Symbol	Parameter	Condition	V <sub>CC</sub>	Guaranteed Limit			Unit
				-55 to 25°C	≤85°C	≤125°C	
R <sub>on</sub>	Maximum “ON” Resistance	V <sub>in</sub> = V <sub>IL</sub> or V <sub>IH</sub> ; V <sub>IS</sub> = V <sub>CC</sub> to GND; I <sub>S</sub> ≤ 2.0 mA	2.0	1700	1750	1800	Ω
			3.0	1100	1200	1300	
			4.5	550	650	750	
			6.0	400	500	600	
ΔR <sub>on</sub>	Delta “ON” Resistance	V <sub>in</sub> = V <sub>IL</sub> or V <sub>IH</sub> ; V <sub>IS</sub> = V <sub>CC</sub> /2; I <sub>S</sub> ≤ 2.0 mA	2.0	300	400	500	Ω
			3.0	160	200	240	
			4.5	80	100	120	
			6.0	60	80	100	
I <sub>off</sub>	Maximum Off-Channel Leakage Current, Any One Channel Common Channel	V <sub>in</sub> = V <sub>CC</sub> or GND	6.0	±0.1	±0.1	±0.1	μA
				±0.1	±0.1	±0.1	
I <sub>on</sub>	Maximum On-Channel Leakage Channel-to-Channel	V <sub>in</sub> = V <sub>CC</sub> or GND	6.0	±0.1	±0.1	±0.1	μA

## AC CHARACTERISTICS (C<sub>L</sub> = 50 pF, Input t<sub>r</sub> = t<sub>f</sub> = 6 ns)

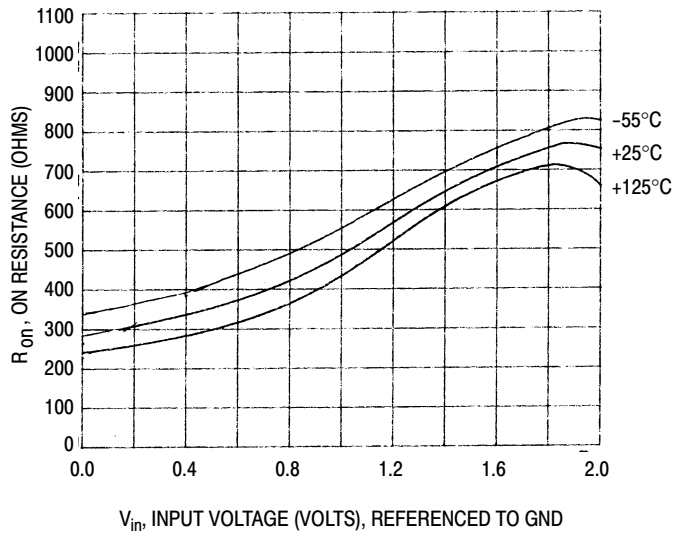
Symbol	Parameter	V <sub>CC</sub>	-55 to 25°C	≤85°C	≤125°C	Unit
t <sub>PHL</sub> , t <sub>PLH</sub>	Maximum Propagation Delay, Analog Input to Analog Output	2.0	160	180	200	ns
		3.0	80	90	100	
		4.5	40	45	50	
		6.0	30	35	40	
t <sub>PHL</sub> , t <sub>PHZ,PZH</sub> , t <sub>PLH</sub> , t <sub>PLZ,PZL</sub>	Maximum Propagation Delay, Enable or Channel-Select to Analog Output	2.0	260	280	300	ns
		3.0	160	180	200	
		4.5	80	90	100	
		6.0	78	80	80	
C <sub>in</sub>	Maximum Input Capacitance (All Switches Off) Any Single Analog Pin (All Switches Off) Common Analog Pin		10	10	10	pF
			35	35	35	
			40	40	40	
C <sub>PD</sub>	Power Dissipation Capacitance	Typical	5.0	20		pF

## INJECTION CURRENT COUPLING SPECIFICATIONS (V<sub>CC</sub> = 5V, T<sub>A</sub> = -55°C to +125°C)

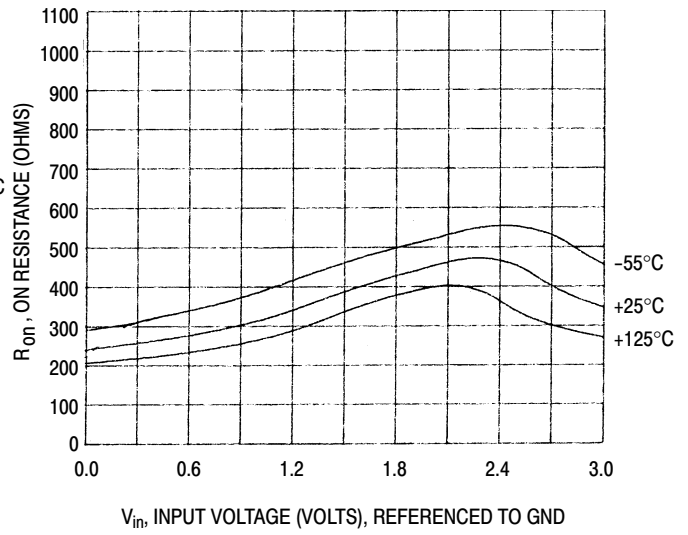
Symbol	Parameter	Condition	Typ	Max	Unit
VΔ <sub>out</sub>	Maximum Shift of Output Voltage of Enabled Analog Channel	I <sub>in</sub> * ≤ 1 mA, R <sub>S</sub> ≤ 3.9 kΩ	0.1	1.0	mV
		I <sub>in</sub> * ≤ 10 mA, R <sub>S</sub> ≤ 3.9 kΩ	1.0	5.0	
		I <sub>in</sub> * ≤ 1 mA, R <sub>S</sub> ≤ 20 kΩ	0.5	2.0	
		I <sub>in</sub> * ≤ 10 mA, R <sub>S</sub> ≤ 20 kΩ	5.0	20	

\* I<sub>in</sub> = Total current injected into all disabled channels.

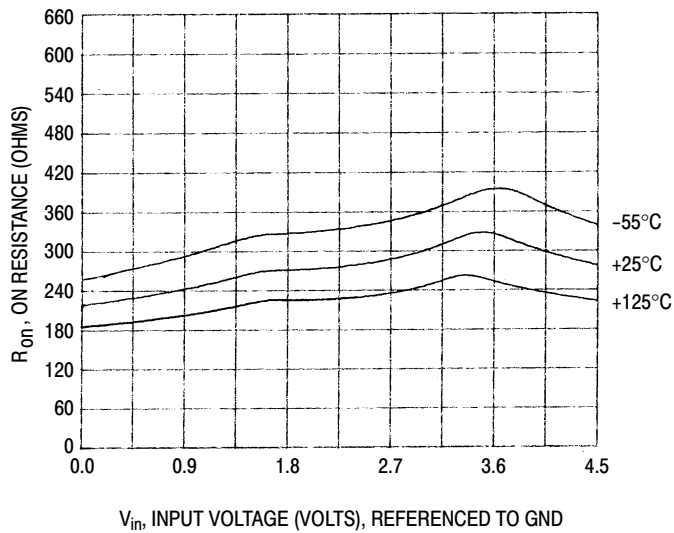
# MC74HC4851A, MC74HC4852A



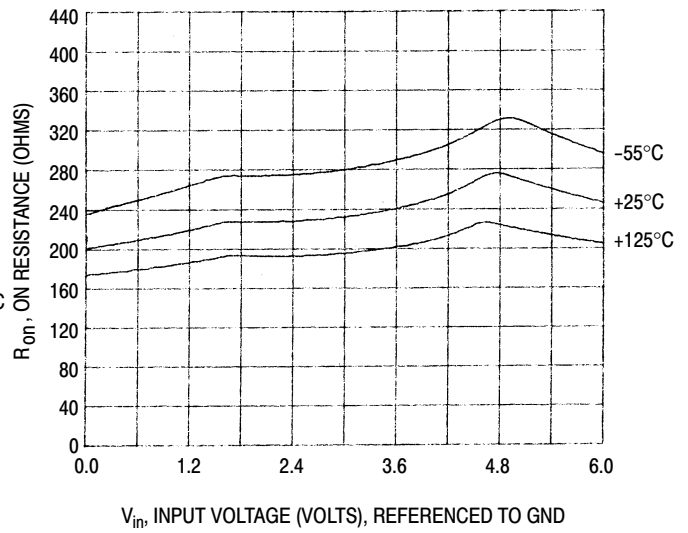
**Figure 5. Typical On Resistance  $V_{CC} = 2V$**



**Figure 6. Typical On Resistance  $V_{CC} = 3V$**

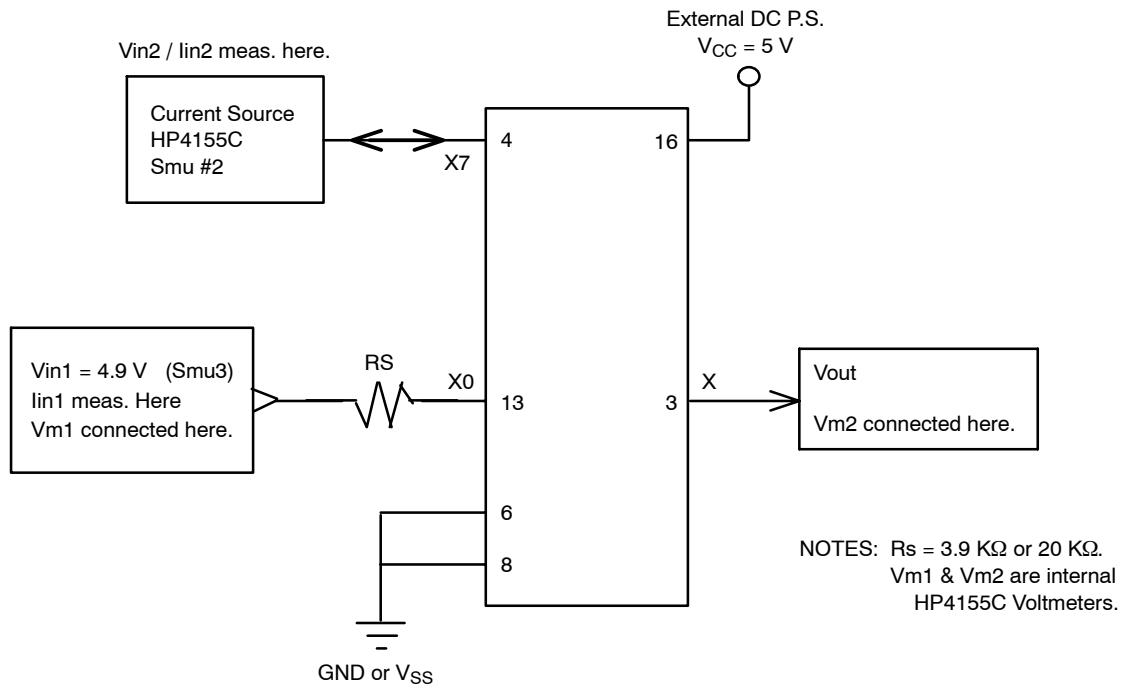


**Figure 7. Typical On Resistance  $V_{CC} = 4.5V$**



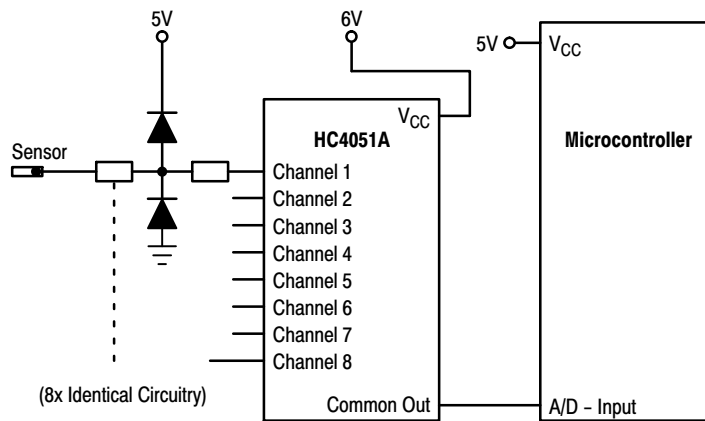
**Figure 8. Typical On Resistance  $V_{CC} = 6V$**

# MC74HC4851A, MC74HC4852A



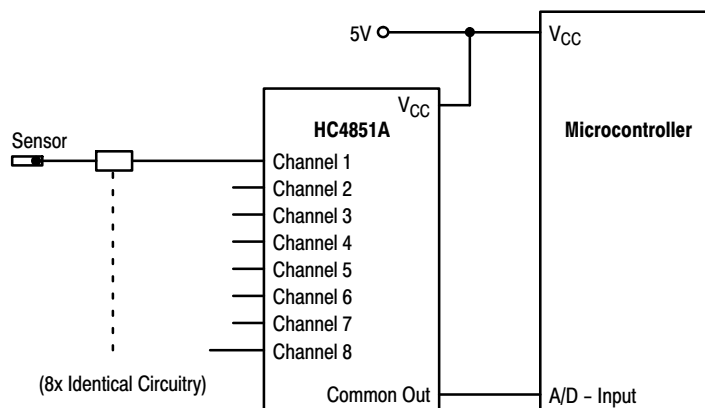
**Figure 9. Injection Current Coupling Specification**

## MC74HC4851A, MC74HC4852A



**Figure 10. Actual Technology**

Requires 32 passive components and one extra 6V regulator to suppress injection current into a standard HC4051 multiplexer



**Figure 11. MC74HC4851A Solution**

Solution by applying the HC4851A multiplexer

# MC74HC4851A, MC74HC4852A

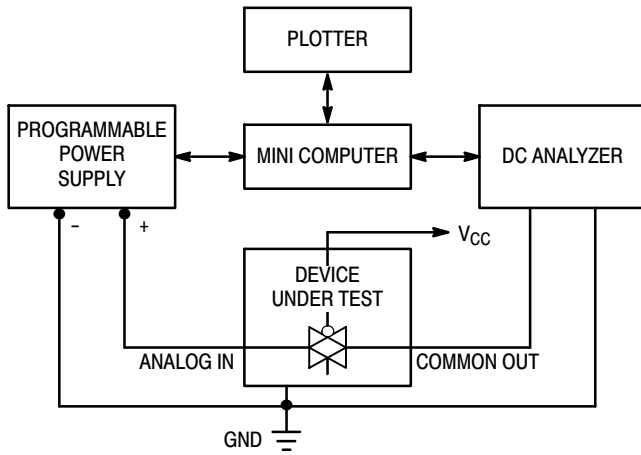


Figure 12. On Resistance Test Set-Up

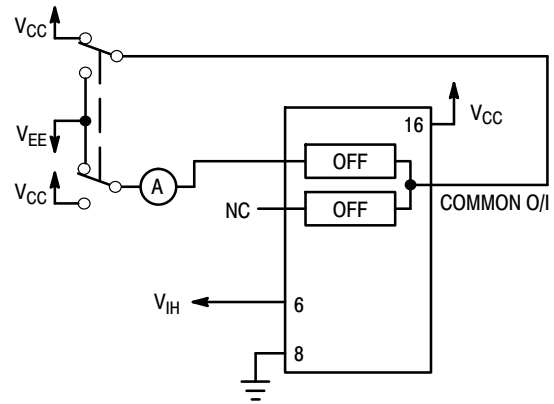


Figure 13. Maximum Off Channel Leakage Current, Any One Channel, Test Set-Up

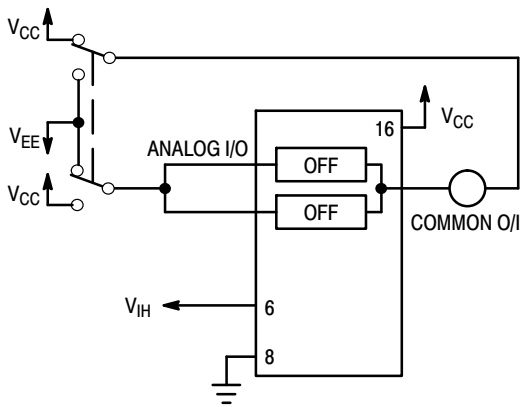


Figure 14. Maximum Off Channel Leakage Current, Common Channel, Test Set-Up

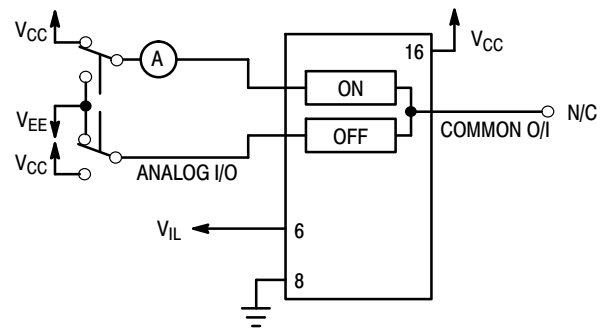


Figure 15. Maximum On Channel Leakage Current, Channel to Channel, Test Set-Up

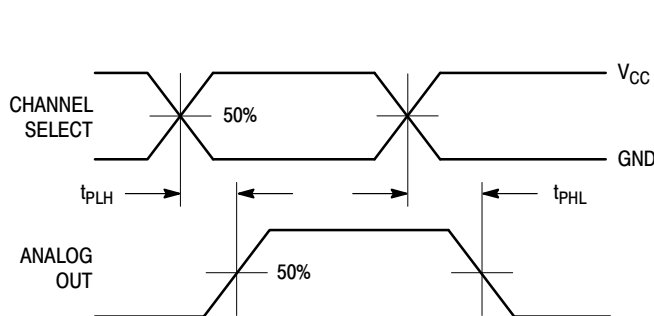
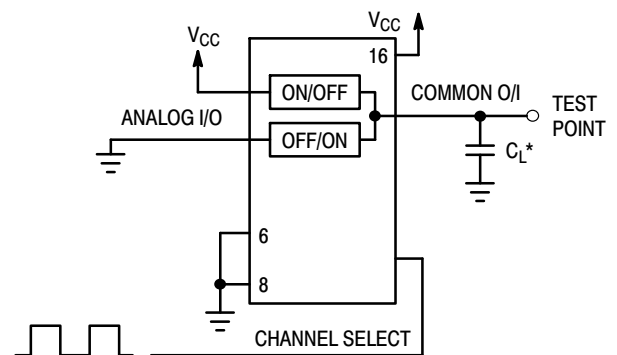


Figure 16. Propagation Delays, Channel Select to Analog Out

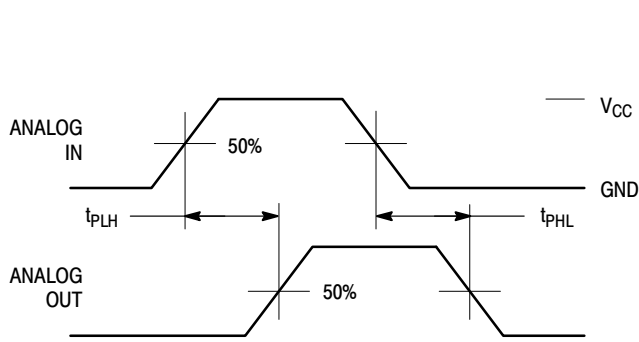


\*Includes all probe and jig capacitance

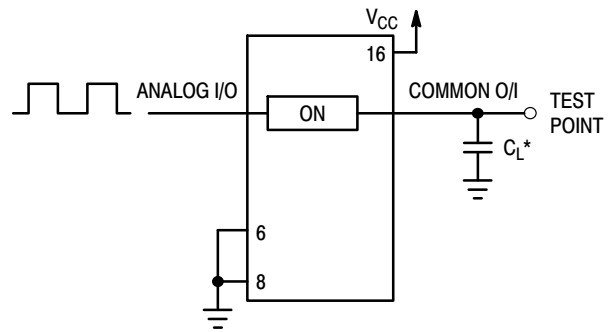
Figure 17. Propagation Delay, Test Set-Up Channel Select to Analog Out



# MC74HC4851A, MC74HC4852A

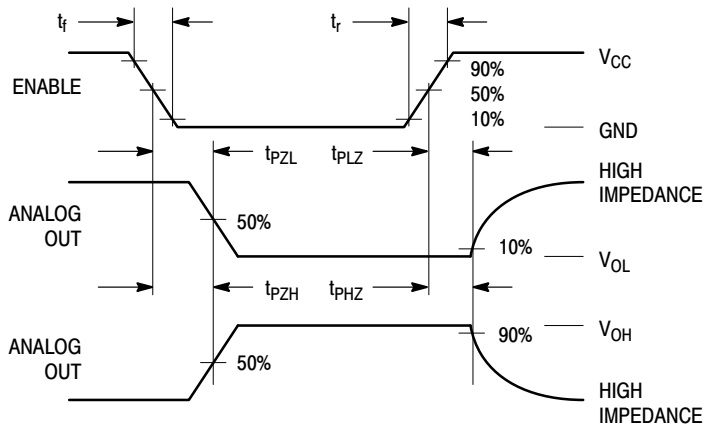


**Figure 18. Propagation Delays, Analog In to Analog Out**

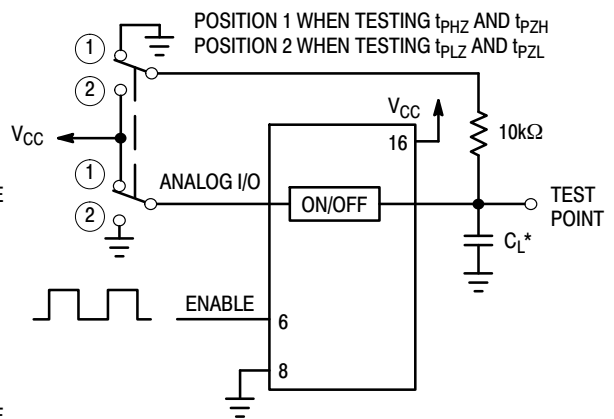


\*Includes all probe and jig capacitance

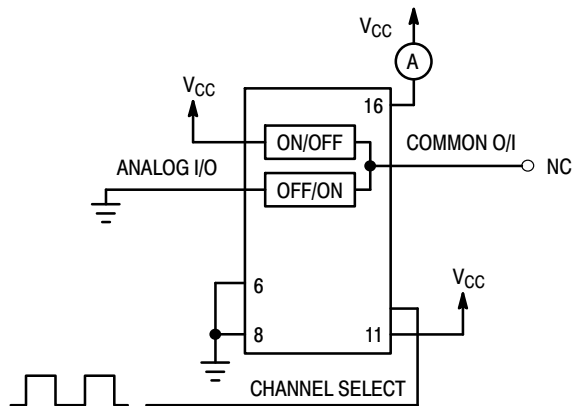
**Figure 19. Propagation Delay, Test Set-Up Analog In to Analog Out**



**Figure 20. Propagation Delays, Enable to Analog Out**

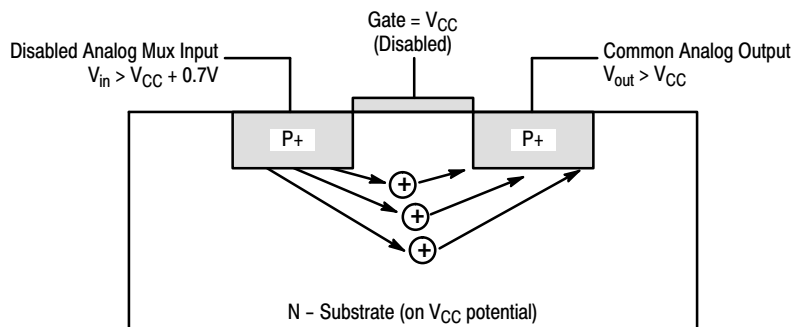


**Figure 21. Propagation Delay, Test Set-Up Enable to Analog Out**

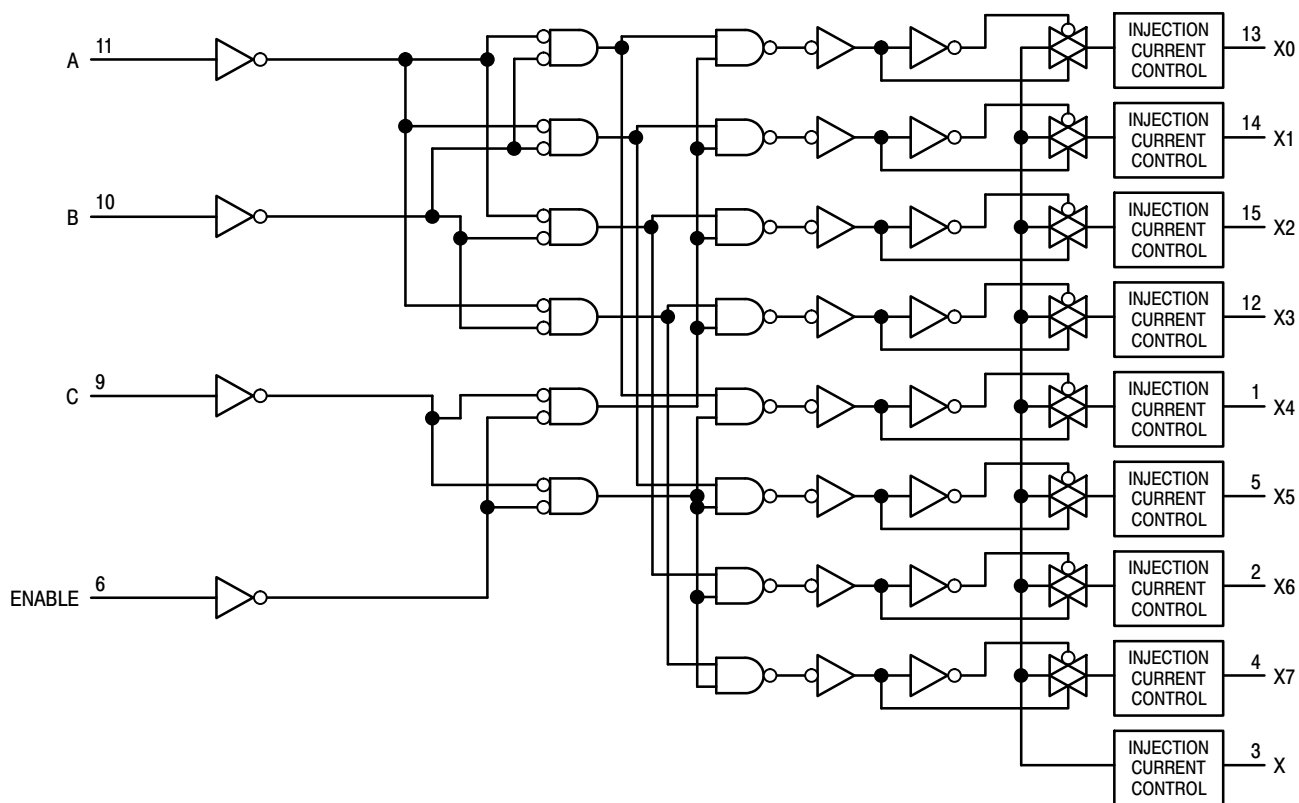


**Figure 22. Power Dissipation Capacitance, Test Set-Up**

## MC74HC4851A, MC74HC4852A



**Figure 23. Diagram of Bipolar Coupling Mechanism**  
Appears if  $V_{in}$  exceeds  $V_{CC}$ , driving injection current into the substrate



**Figure 24. Function Diagram, HC4851A**

# MC74HC4851A, MC74HC4852A

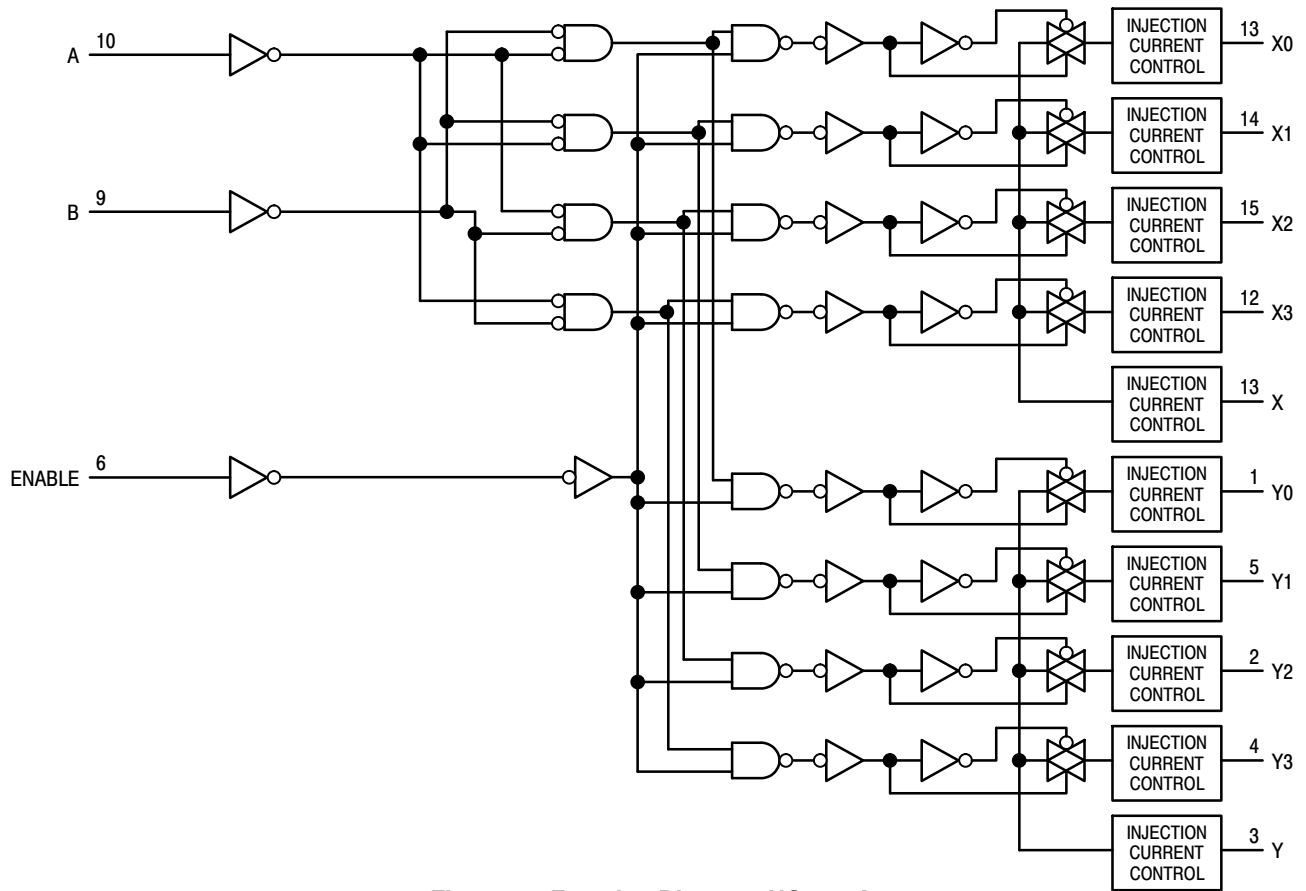


Figure 25. Function Diagram, HC4852A

## MC74HC4851A, MC74HC4852A

### ORDERING INFORMATION

Device	Package	Shipping†
MC74HC4851ANG	PDIP-16 (Pb-Free)	500 Units / Box
MC74HC4851ADG	SOIC-16 (Pb-Free)	48 Units / Rail
MC74HC4851ADR2G		2500 Units / Tape & Reel
NLVHC4851ADR2G*		2500 Units / Tape & Reel
MC74HC4851ADTR2G	TSSOP-16 (Pb-Free)	2500 Units / Tape & Reel
NLVHC4851ADTR2G*		2500 Units / Tape & Reel
MC74HC4851ADWR2G	SOIC-16 WIDE (Pb-Free)	1000 Units / Tape & Reel
MC74HC4852ANG	PDIP-16 (Pb-Free)	500 Units / Box
MC74HC4852ADG	SOIC-16 (Pb-Free)	48 Units / Rail
MC74HC4852ADR2G		2500 Units / Tape & Reel
NLV74HC4852ADR2G*		2500 Units / Tape & Reel
MC74HC4852ADTR2G	TSSOP-16 (Pb-Free)	2500 Units / Tape & Reel
NLVHC4852ADTR2G*		2500 Units / Tape & Reel

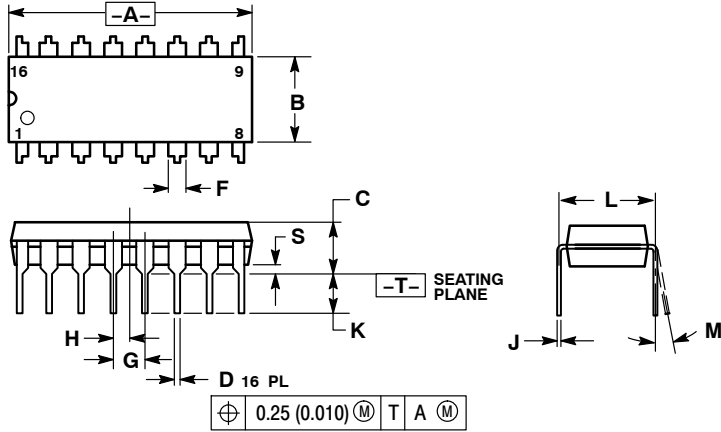
†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

\*NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable.

# MC74HC4851A, MC74HC4852A

## PACKAGE DIMENSIONS

PDIP-16  
N SUFFIX  
CASE 648-08  
ISSUE T



### NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
5. ROUNDED CORNERS OPTIONAL.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.740	0.770	18.80	19.55
B	0.250	0.270	6.35	6.85
C	0.145	0.175	3.69	4.44
D	0.015	0.021	0.39	0.53
F	0.040	0.70	1.02	1.77
G	0.100 BSC		2.54 BSC	
H	0.050 BSC		1.27 BSC	
J	0.008	0.015	0.21	0.38
K	0.110	0.130	2.80	3.30
L	0.295	0.305	7.50	7.74
M	0°	10°	0°	10°
S	0.020	0.040	0.51	1.01

## PACKAGE DIMENSIONS

Technical drawing of a seat base assembly, showing front, side, and detail views with dimensions and material specifications.

**Front View:** Shows a rectangular base with dimensions  $16$  (width) and  $9$  (height). The top edge is labeled  $-A-$  and the bottom edge is labeled  $-B-$ . The bottom edge is also labeled  $8$ . The material specification is  $P 8 PL$  with a surface finish of  $\oplus 0.25 (0.010) (M) B \textcircled{S}$ .

**Side View:** Shows the base with dimensions  $16$  (width) and  $8$  (height). The bottom edge is labeled  $8$ . The material specification is  $P 8 PL$  with a surface finish of  $\oplus 0.25 (0.010) (M) B \textcircled{S}$ .

**Detail View:** Shows a cross-section of the base with dimensions  $R \times 45^\circ$  (radius),  $F$  (height),  $J$  (width), and  $M$  (width). The material specification is  $P 8 PL$  with a surface finish of  $\oplus 0.25 (0.010) (M) B \textcircled{S}$ .

**Seating Plane View:** Shows the base with dimensions  $16$  (width) and  $8$  (height). The bottom edge is labeled  $8$ . The material specification is  $P 8 PL$  with a surface finish of  $\oplus 0.25 (0.010) (M) B \textcircled{S}$ .

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	9.80	10.00	0.386	0.393
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27 BSC		0.050 BSC	
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
M	0°	7°	0°	7°
P	5.80	6.20	0.229	0.244
R	0.25	0.50	0.010	0.019

Diagram illustrating the dimensions of a 16X0.58mm pitch tape. The tape is shown with 16 rows and 8 columns. The dimensions are defined as follows:

- Overall width: 8X 6.40
- Overall height: 16X 1.12
- Row pitch: 1.27 PITCH
- Column pitch: 0.58

DIMENSIONS: MILLIMETERS

14

## PACKAGE DIMENSIONS

Technical drawing of a 16-pin D-sub connector. The drawing includes three views: a top view, a side view, and a detail view of the pin and shell interface.

**Top View:** Shows a rectangular connector housing with 16 pins. The overall width is labeled  $D$ . The height of the housing is labeled  $E$ . The pin pitch is labeled  $B$ . The total pin length is labeled  $16 \times B$ . The pin diameter is labeled  $0.25 \text{ (M)}$ . The pin numbering is indicated by 1 through 16. The connector is labeled with a circled  $\oplus$  and a circled  $\text{M}$ .

**Side View:** Shows the profile of the connector. The overall height is labeled  $8 \times H$ . The pin height is labeled  $A$ . The pin diameter is labeled  $0.25 \text{ (M)}$ . The pin numbering is indicated by 1 through 16. The connector is labeled with a circled  $\oplus$  and a circled  $\text{M}$ .

**Detail View:** Shows a close-up of the pin and shell interface. The pin is labeled  $T$ . The shell is labeled  $A$ . The pin diameter is labeled  $0.25 \text{ (M)}$ . The pin numbering is indicated by 1 through 16. The connector is labeled with a circled  $\oplus$  and a circled  $\text{M}$ .

**Labels:** The drawing includes labels for dimensions ( $D$ ,  $E$ ,  $B$ ,  $16 \times B$ ,  $0.25 \text{ (M)}$ ,  $8 \times H$ ,  $A$ ,  $14 \times e$ ,  $L$ ,  $C$ ) and connector specifications ( $\oplus$ ,  $\text{M}$ ,  $T$ ,  $A$ ,  $S$ ,  $B$ ,  $S$ ).

1. DIMENSIONS ARE IN MILLIMETERS.
2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.
3. DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
5. DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF THE B DIMENSION AT MAXIMUM MATERIAL CONDITION.

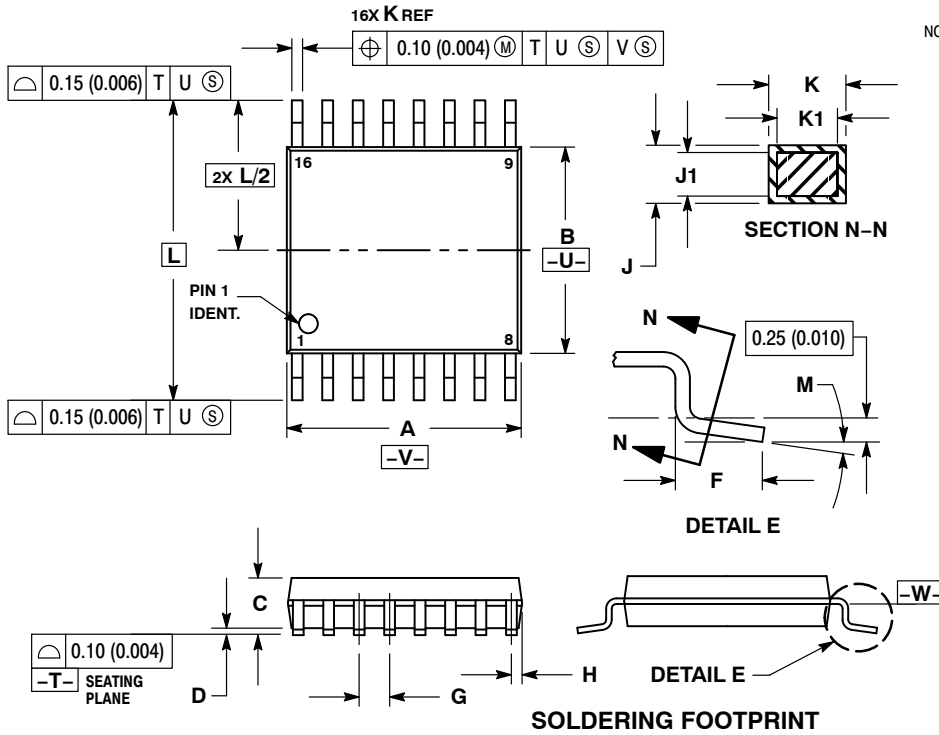
	MILLIMETERS	
DIM	MIN	MAX
A	2.35	2.65
A1	0.10	0.25
B	0.35	0.49
C	0.23	0.32
D	10.15	10.45
E	7.40	7.60
e	1.27 BSC	
H	10.05	10.55
h	0.25	0.75
L	0.50	0.90
a	0°	7°

DIMENSIONS: MILLIMETERS

# MC74HC4851A, MC74HC4852A

## PACKAGE DIMENSIONS

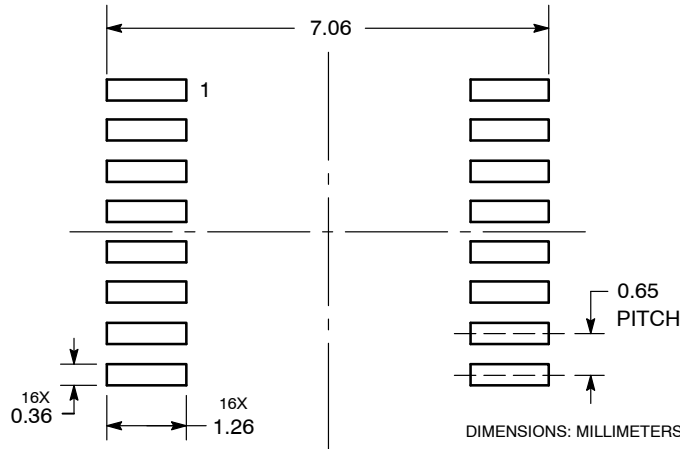
TSSOP-16  
DT SUFFIX  
CASE 948F  
ISSUE B



### NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.90	5.10	0.193	0.200
B	4.30	4.50	0.169	0.177
C	---	1.20	---	0.047
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.65 BSC		0.026 BSC	
H	0.18	0.28	0.007	0.011
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.19	0.30	0.007	0.012
K1	0.19	0.25	0.007	0.010
L	6.40 BSC		0.252 BSC	
M	0°	8°	0°	8°



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